## **AMENDMENTS TO THE CLAIMS**

This is a complete and current listing of the claims, marked with status identifiers in parentheses. The following listing of claims will replace all prior versions and listings of claims in the application.

1. (Currently Amended) A method to drill holes for drilling a hole in an electric circuit substrate with the help of using a laser beam, which is to be set via a deflection optics unit and an imaging unit to ana individual drill position and to be subsequently guided within the area of an intended drill hole in a circular movement, the method comprising:

performing movement and centering of the laser beam axis—to the individual—a drill position byusing way of a first deflection unit;

continuously modulating the circular movement onto the laser beam viamoving a second deflection unit for modulating to modulate the laser beam to the circular movement, whereas the second deflection unit is being placed in the a position preceding the first deflection unit; and

turning on the laser beam on when the first deflection unit is at a standstill.

2. (Original) The method according to claim 1, wherein the circular movement of the laser beam is created by two overlapping, sinusoidal movements of the second deflection unit, the sinusoidal movements being out of phase by 90°.

3. (Original) The method according to claim 1, wherein the deflection in the second deflection unit is created by overlapping more than two individual movements.

4.-12. (Cancelled)